

3.5x2.8 mm SMD CHIP LED LAMP

APED3528VGC

GREEN

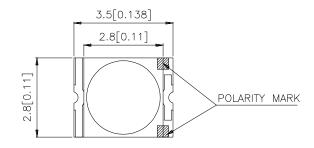
Features

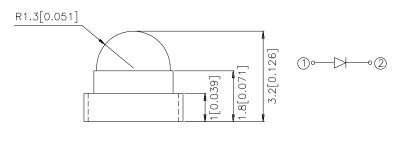
- •SINGLE COLOR.
- •SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- •IDEAL FOR BACKLIGHTING.
- •AVAILABLE ON TAPE AND REEL.
- •PACKAGE: 500PCS/REEL.

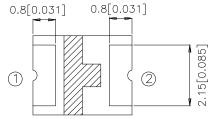
Description

The Green source color devices are made with InGaN on SiC Light Emitting Diode.

Package Dimensions







Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.0079")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20 mA		Viewing Angle
			Min.	Тур.	201/2
APED3528VGC	GREEN (InGaN)	WATER CLEAR	110	300	40°

Note:

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	I=20mA
λD	Dominate Wavelength	Green	525		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Green	38		nm	I=20mA
С	Capacitance	Green	45		pF	V _F =0V;f=1MHz
VF	Forward Voltage	Green	4.0	4.5	V	I=20mA
IR	Reverse Current	Green		10	uA	V _R = 5V

Absolute Maximum Ratings at T_A=25°C

Parameter	Green	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

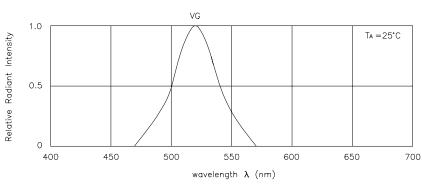
Note:

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^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

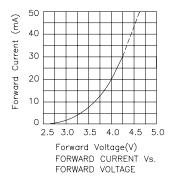
^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

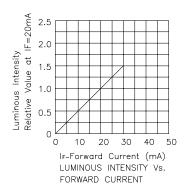
Kingbright

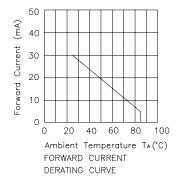


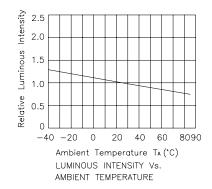
RELATIVE INTENSITY Vs. WAVELENGTH

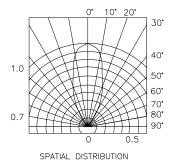
Green APED3528VGC











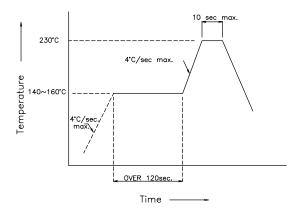
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Kingbright

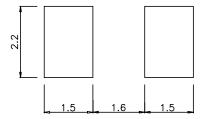
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SMT Reflow Soldering Instructions

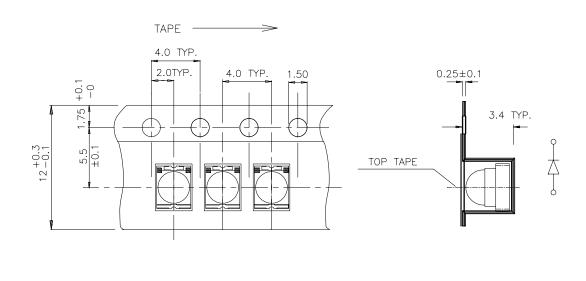
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units:mm)



Tape Specifications (Units:mm)



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